

AUTOMOTIVE

HALOGEN FREE

Surface-Mount PAR® Transient Voltage Suppressors

High Temperature Stability and High Reliability Conditions



SlimSMA (DO-221AC)



LINKS TO ADDITIONAL RESOURCES









| PRIMARY CHARACTERISTICS | | | | | |
|--|--------------------|--|--|--|--|
| V_{BR} | 6.8 V to 100 V | | | | |
| V_{WM} | 5.8 V to 85.5 V | | | | |
| Р _{РРМ} (10 x 1000 µs) | 600 W | | | | |
| P _D at T _M = 65 °C | 8 W | | | | |
| T _J max. | 185 °C | | | | |
| Polarity | Unidirectional | | | | |
| Package | SlimSMA (DO-221AC) | | | | |

FEATURES

- Very low profile typical height of 0.95 mm
- Junction passivation optimized design passivated anisotropic rectifier technology
- T_J = 185 °C capability suitable for high reliability and automotive requirement
- · Ideal for automated placement
- Unidirectional
- Excellent clamping capability
- Peak pulse power: 600 W (10/1000 μs)
- AEC-Q101 qualified
- ESD protection up to 30 kV per IEC 61000-4-2
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

TYPICAL APPLICATIONS

Use in sensitive electronics protection against voltage transients induced by inductive load switching and lightning on ICs, MOSFET, signal lines of sensor units for automotive.

MECHANICAL DATA

Case: SlimSMA (DO-221AC)

Molding compound meets UL 94 V-0 flammability rating

Base P/NHM3_X - halogen-free, RoHS-compliant and AEC-Q101 qualified ("_X" denotes revision code e.g. A, B,....)

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD22-B102

HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

| MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted) | | | | | | |
|---|-----------------------------------|---------------------------------|----------------|------|--|--|
| PARAMETER | | SYMBOL | VALUE | UNIT | | |
| Peak pulse power dissipation | with a 10/1000 µs waveform | P _{PPM} ⁽¹⁾ | 600 | W | | |
| Peak pulse current | with a 10/1000 µs waveform | I _{PPM} ⁽¹⁾ | See next table | А | | |
| Dawer discination | T _M = 65 °C | P _D ⁽²⁾ | 8 | w | | |
| Power dissipation | T _A = 25 °C | P _D ⁽³⁾ | 1.1 | | | |
| Operating junction and storage tempe | T _J , T _{STG} | -65 to +185 | °C | | | |

Notes

- (1) Non-repetitive current pulse, per fig. 3 and derated above T_A = 25 °C per fig. 2
- (2) Power dissipation mounted on infinite heat sink
- (3) Power dissipation mounted on minimum recommended pad layout



| ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | | | | | | | |
|---|---------------------------|---|------|-----------------|---|---------|--|--|---|---|---------------|
| DEVICE D | DEVICE MARKING CODE | BREAKDOWN VOLTAGE V _{BR} ⁽¹⁾ AT I _T (V) | | TEST CURRENT | STAND-OFF VOLTAGE V _{WM} | MAXIMUM | T _J = 150 °C MAXIMUM REVERSE LEAKAGE | MAXIMUM PEAK PULSE SURGE | MAXIMUM CLAMPING VOLTAGE AT I _{PPM} | TYPICAL TEMP. COEFFICIENT OF V _{BR} (2) | |
| | | MIN. | ном. | MAX. | (mA) | (V) | Ι _R (μ A) | AT V _{WM} Ι _R (μΑ) | CURRENT I _{PPM} (A) | V _C (V) | αΤ΄ (%/°C) |
| TA6F6.8A | AEP | 6.45 | 6.80 | 7.14 | 10 | 5.80 | 500 | 1000 | 57.1 | 10.5 | 0.047 |
| TA6F7.5A | AGP | 7.13 | 7.50 | 7.88 | 10 | 6.40 | 250 | 500 | 53.1 | 11.3 | 0.052 |
| TA6F8.2A | AKP | 7.79 | 8.20 | 8.61 | 10 | 7.02 | 100 | 200 | 49.6 | 12.1 | 0.056 |
| TA6F9.1A | AMP | 8.65 | 9.10 | 9.55 | 1.0 | 7.78 | 25 | 50 | 44.8 | 13.4 | 0.060 |
| TA6F10A | APP | 9.5 | 10.0 | 10.5 | 1.0 | 8.55 | 5.0 | 20 | 41.4 | 14.5 | 0.064 |
| TA6F11A | ARP | 10.5 | 11.0 | 11.6 | 1.0 | 9.40 | 2.0 | 5.0 | 38.5 | 15.6 | 0.067 |
| TA6F12A | ATP | 11.4 | 12.0 | 12.6 | 1.0 | 10.2 | 2.0 | 5.0 | 35.9 | 16.7 | 0.070 |
| TA6F13A | AVP | 12.4 | 13.0 | 13.7 | 1.0 | 11.1 | 2.0 | 5.0 | 33.0 | 18.2 | 0.072 |
| TA6F15A | AXP | 14.3 | 15.0 | 15.8 | 1.0 | 12.8 | 1.0 | 5.0 | 28.3 | 21.2 | 0.076 |
| TA6F16A | AZP | 15.2 | 16.0 | 16.8 | 1.0 | 13.6 | 1.0 | 5.0 | 26.7 | 22.5 | 0.078 |
| TA6F18A | BEP | 17.1 | 18.0 | 18.9 | 1.0 | 15.3 | 1.0 | 5.0 | 23.5 | 25.5 | 0.080 |
| TA6F20A | BGP | 19.0 | 20.0 | 21.0 | 1.0 | 17.1 | 1.0 | 5.0 | 21.7 | 27.7 | 0.082 |
| TA6F22A | BKP | 20.9 | 22.0 | 23.1 | 1.0 | 18.8 | 1.0 | 5.0 | 19.6 | 30.6 | 0.084 |
| TA6F24A | BMP | 22.8 | 24.0 | 25.2 | 1.0 | 20.5 | 1.0 | 5.0 | 18.1 | 33.2 | 0.085 |
| TA6F27A | BPP | 25.7 | 27.0 | 28.4 | 1.0 | 23.1 | 1.0 | 5.0 | 16.0 | 37.5 | 0.087 |
| TA6F30A | BRP | 28.5 | 30.0 | 31.5 | 1.0 | 25.6 | 1.0 | 5.0 | 14.5 | 41.4 | 0.088 |
| TA6F33A | BTP | 31.4 | 33.0 | 34.7 | 1.0 | 28.2 | 1.0 | 5.0 | 13.1 | 45.7 | 0.089 |
| TA6F36A | BVP | 34.2 | 36.0 | 37.8 | 1.0 | 30.8 | 1.0 | 5.0 | 12.0 | 49.9 | 0.090 |
| TA6F39A | BXP | 37.1 | 39.0 | 41.0 | 1.0 | 33.3 | 1.0 | 5.0 | 11.1 | 53.9 | 0.091 |
| TA6F43A | BZP | 40.9 | 43.0 | 45.2 | 1.0 | 36.8 | 1.0 | 10.0 | 10.1 | 59.3 | 0.092 |
| TA6F47A | CEP | 44.7 | 47.0 | 49.4 | 1.0 | 40.2 | 1.0 | 10.0 | 9.3 | 64.8 | 0.092 |
| TA6F51A | CGP | 48.5 | 51.0 | 53.6 | 1.0 | 43.6 | 1.0 | 10.0 | 8.6 | 70.1 | 0.093 |
| TA6F56A | CKP | 53.2 | 56.0 | 58.8 | 1.0 | 47.8 | 1.0 | 10.0 | 7.8 | 77.0 | 0.096 |
| TA6F62A | CMP | 58.9 | 62.0 | 65.1 | 1.0 | 53.0 | 1.0 | 10.0 | 7.1 | 85.0 | 0.096 |
| TA6F68A | CPP | 64.6 | 68.0 | 71.4 | 1.0 | 58.1 | 1.0 | 10.0 | 6.5 | 92.0 | 0.097 |
| TA6F75A | CRP | 71.3 | 75.0 | 78.8 | 1.0 | 64.1 | 1.0 | 10.0 | 5.8 | 104 | 0.097 |
| TA6F82A | CTP | 77.9 | 82.0 | 86.1 | 1.0 | 70.1 | 1.0 | 10.0 | 5.3 | 113 | 0.097 |
| TA6F91A | CVP | 86.5 | 91.0 | 95.6 | 1.0 | 77.8 | 1.0 | 15.0 | 4.8 | 125 | 0.098 |
| TA6F100A | CXP | 95.0 | 100 | 105 | 1.0 | 85.5 | 1.0 | 15.0 | 4.4 | 137 | 0.098 |

Notes

⁽²⁾ To calculate V_{BR} vs. junction temperature, use the following formula: V_{BR} at $T_J = V_{BR}$ at 25 °C x (1 + α T x (T_J - 25))

| THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | | |
|---|-----------------------|-----|-----|------|--|--|
| PARAMETER SYMBOL TYP. MAX. UNIT | | | | | | |
| Thermal resistance | R _{eJA} (1) | 120 | 150 | °C/W | | |
| Thermal resistance | R _{e IM} (2) | 12 | 15 | °C/W | | |

Notes

(1) Thermal resistance junction-to-ambient to follow JEDEC® 51-2A, device mounted on FR4 PCB, 2 oz. standard footprint

⁽²⁾ Thermal resistance junction-to-mount to follow JEDEC® 51-14, using TDIM (transient dual interface test method)

| IMMUNITY TO STATIC ELECTRICAL DISCHARGE TO THE FOLLOWING STANDARDS (T _A = 25 °C unless otherwise noted) | | | | | | | |
|--|--|--------------------------------------|-----|-------|--|--|--|
| STANDARD | TEST TYPE TEST CONDITIONS SYMBOL VALUE | | | | | | |
| IEC 61000-4-2 | Contact discharge | $C = 150 \text{ pF}, R = 330 \Omega$ | ESD | 30 kV | | | |
| IEC 61000-4-2 | Air discharge | C = 150 pr, h = 550 \(\omega \) | ESD | 30 kV | | | |

| ORDERING INFORMATION (Example) | | | | | | |
|--------------------------------|-----------------|------------------------|---------------|------------------------------------|--|--|
| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE | | |
| TA6F6.8AHM3_A/H (1) | 0.032 | Н | 3500 | 7" diameter plastic tape and reel | | |
| TA6F6.8AHM3_A/I (1) | 0.032 | I | 14 000 | 13" diameter plastic tape and reel | | |

Note

(1) AEC-Q101 qualified

⁽¹⁾ Pulse test: $t_p \le 50$ ms

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

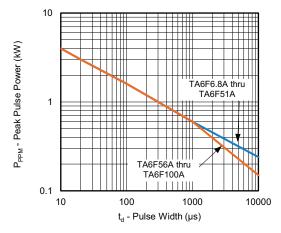


Fig. 1 - Peak Pulse Power Rating Curve

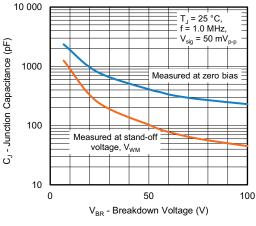


Fig. 4 - Typical Junction Capacitance

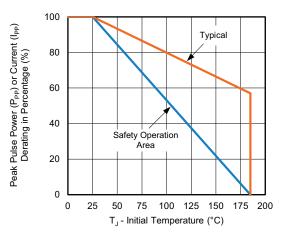


Fig. 2 - Pulse Power or Current vs. Initial Junction Temperature

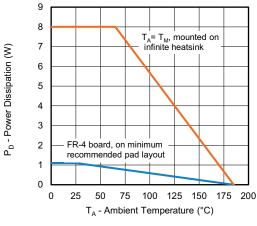


Fig. 5 - Power Dissipation Derating Curve

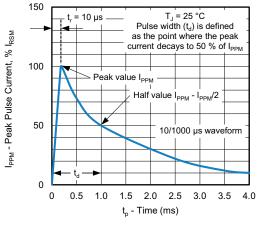


Fig. 3 - Pulse Waveform

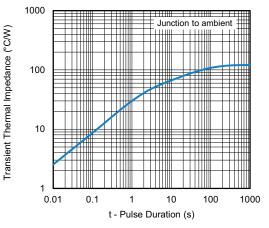
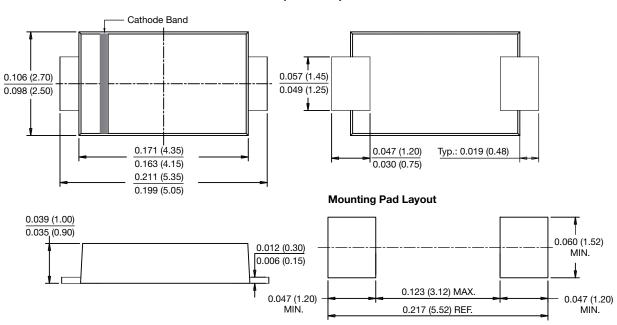


Fig. 6 - Typical Transient Thermal Impedance



PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SlimSMA (DO-221AC)





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